

SURFACE MOUNT TRIPLE ISOLATED ULTRA LOW LEAKAGE SILICON SWITCHING DIODES





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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMKD6001 type contains three (3) Isolated Silicon Switching Diodes, manufactured by the epitaxial planar process, epoxy molded in a ULTRAmini[™] surface mount package, designed for switching applications requiring extremely low leakage.

MARKING CODE: K01

MAXIMUM RATINGS: (T _A =25°C) Continuous Reverse Voltage	symbol V _R	75	UNITS V
Peak Repetitive Reverse Voltage	V _{RRM}	100	V
Continuous Forward Current	١ _F	250	mA
Peak Repetitive Forward Current	IFRM	500	mA
Peak Forward Surge Current, tp=1.0µs	IFSM	4.0	А
Peak Forward Surge Current, tp=1.0s	IFSM	1.0	А
Power Dissipation	PD	250	mW
Operating and Storage Junction Temperature	TJ, Tstg	-65 to +150	°C
Thermal Resistance	Θ _{JA}	500	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (TA=25°C unless otherwise noted)

symbol I _R	TEST CONDITIONS V _R =75V	MIN	MAX 500	UNITS pA
BVR	Ι _R =100μΑ	100		V
V _F	I _F =1.0mA		0.85	V
V _F	I _F =10mA		0.95	V
V _F	I _F =100mA		1.1	V
с _Т	V _R =0, f=1.0MHz		2.0	pF
t _{rr}	$I_R=I_F=10mA$, $I_{rr}=1.0mA$, $R_L=100\Omega$		3.0	μs

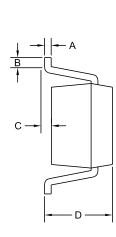
R5 (9-May 2011)

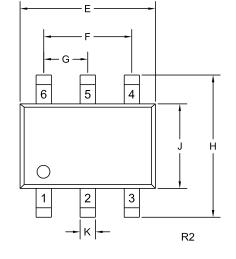


CMKD6001

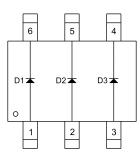
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SOT-363 CASE - MECHANICAL OUTLINE





PIN CONFIGURATION



LEAD CODE:

Anode D1
Anode D2
Anode D3
Cathode D3
Cathode D2
Cathode D2
Cathode D1

MARKING CODE: K01

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
А	0.004	0.010	0.10	0.25			
В	0.005	-	0.12	-			
С	0.000	0.004	0.00	0.10			
D	0.031	0.043	0.80	1.10			
Е	0.071	0.087	1.80	2.20			
F	0.051		1.30				
G	0.026		0.65				
Н	0.075	0.091	1.90	2.30			
J	0.043	0.055	1.10	1.40			
K	0.006	0.012	0.15	0.30			
SOT-363 (REV: R2)							

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R5 (9-May 2011)

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

CONTACT US

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